



PESD2ETH1GT-Q

ESD protection for in-vehicle networks

29 March 2023

Product data sheet

1. General description

Fully OPEN Alliance 100BASE-T1 and 1000BASE-T1 compliant Electrostatic Discharge (ESD) protection device in a small SOT23 surface-mounted plastic package, designed to protect two automotive in-vehicle network bus lines from the damage caused by ESD and other transients.

2. Features and benefits

- Fully OPEN Alliance 100BASE-T1 and 1000BASE-T1 compliant
- High trigger voltage: $V_{t1} = 100$ V min.
- Low capacitance: $C_d < 2$ pF
- ESD protection up to 30 kV (IEC 61000-4-2)
- 1000 contact discharges (OPEN Alliance specification) with 15 kV (IEC 61000-4-2)
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

ESD protection for in-vehicle network lines in automotive environments

- OPEN Alliance 100/1000BASE-T1 Ethernet
- Low-Voltage Differential Signaling (LVDS) automotive

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V_{RWM}	reverse standoff voltage	$T_{amb} = 25$ °C	-	-	24	V	
C_d	diode capacitance	$f = 1$ MHz; $V_R = 0$ V; $T_{amb} = 25$ °C	-	1.8	2	pF	
V_{t1}	trigger voltage	$t_p = 100$ ns; $T_{amb} = 25$ °C	[1]	100	130	-	V
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[2] [3]	30	-	-	kV
		1000 contact discharges (IEC 61000-4-2); OPEN Alliance specification	[3]	15	-	-	kV

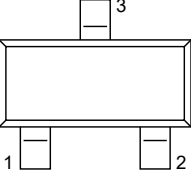
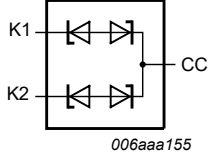
[1] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008

[2] Device stressed with ten non-repetitive ESD pulses.

[3] Measured from pin 1 or 2 to pin 3.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 <p style="text-align: center;">SOT23</p>	
2	K	cathode		
3	CC	common cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD2ETH1GT-Q	SOT23	plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23

7. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
PESD2ETH1GT-Q	%HK

[1] % = placeholder for manufacturing site code

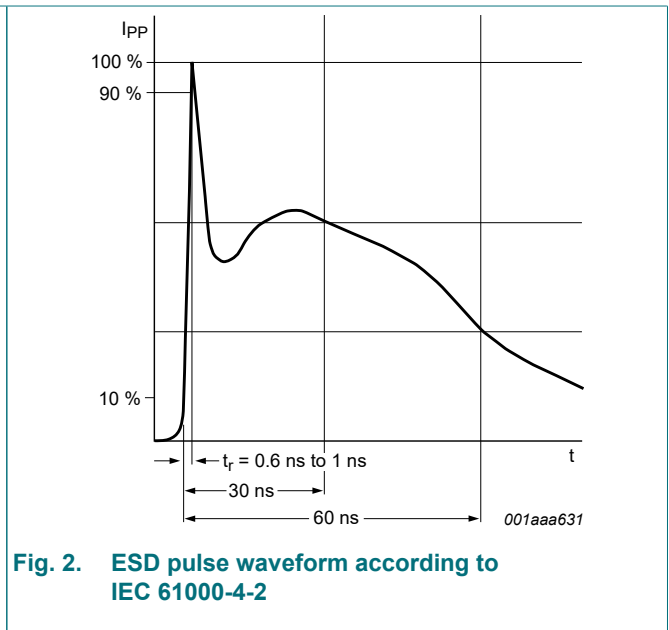
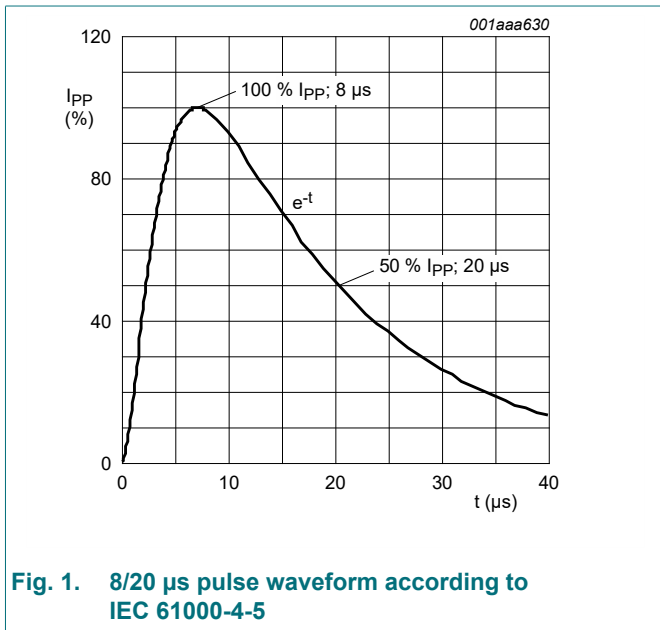
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134)

Symbol	Parameter	Conditions		Min	Max	Unit
I_{PPM}	rated peak pulse current	$t_p = 8/20 \mu s$	[1] [2]	-	2.3	A
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[3] [2]	30	-	kV
		ISO 10605; contact discharge; C = 150 pF; R = 330 Ω	[3] [2]	30	-	kV
		ISO 10605; contact discharge; C = 330 pF; R = 330 Ω	[3] [2]	30	-	kV
		1000 contact discharges (IEC 61000-4-2); OPEN Alliance specification	[2]	15	-	kV

- [1] Device stressed with 8/20 μs exponential decay waveform according to IEC 61000-4-5.
- [2] Measured from pin 1 or 2 to pin 3.
- [3] Device stressed with ten non-repetitive ESD pulses.



9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{RWM}	reverse standoff voltage	$T_{amb} = 25\text{ °C}$		-	-	24	V
V_h	holding voltage	$t_p = 100\text{ ns}; T_{amb} = 25\text{ °C}$	[1]	28	-	-	V
V_{t1}	trigger voltage		[1]	100	130	-	V
I_{RM}	reverse leakage current	$V_{RWM} = 24\text{ V}; V_R = 0\text{ V}; T_{amb} = 25\text{ °C}$		-	1	100	nA
C_d	diode capacitance	$f = 1\text{ MHz}; V_R = 0\text{ V}; T_{amb} = 25\text{ °C}$		-	1.8	2	pF
$\Delta C_d/C_d$	diode capacitance matching		[2]	-	0.5	-	%
		$f = 1\text{ MHz}; V_R = 2.5\text{ V}; T_{amb} = 25\text{ °C}$	[2]	-	0.5	-	%
R_{dyn}	dynamic resistance	$I_R = 40\text{ A}; t_p = 100\text{ ns}; T_{amb} = 25\text{ °C}$	[1]	-	0.6	-	Ω

[1] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008

[2] ΔC_d is the difference of the capacitance measured between pin 1 and pin 3 and the capacitance measured between pin 2 and pin 3.

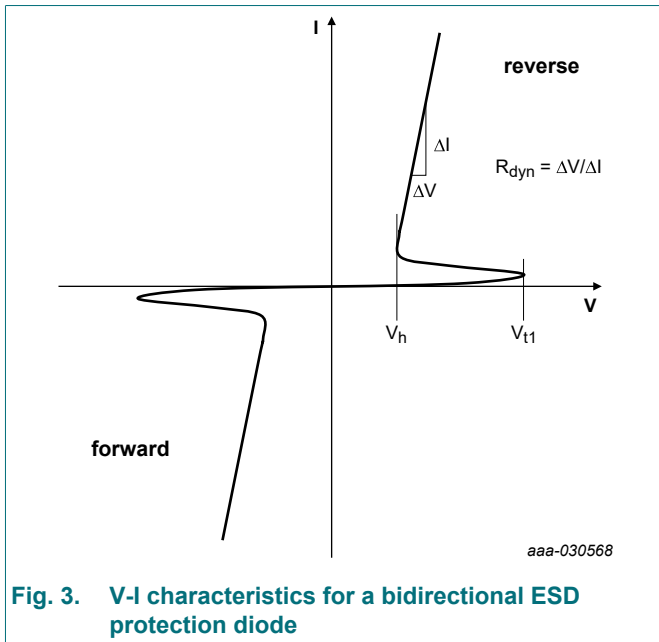


Fig. 3. V-I characteristics for a bidirectional ESD protection diode

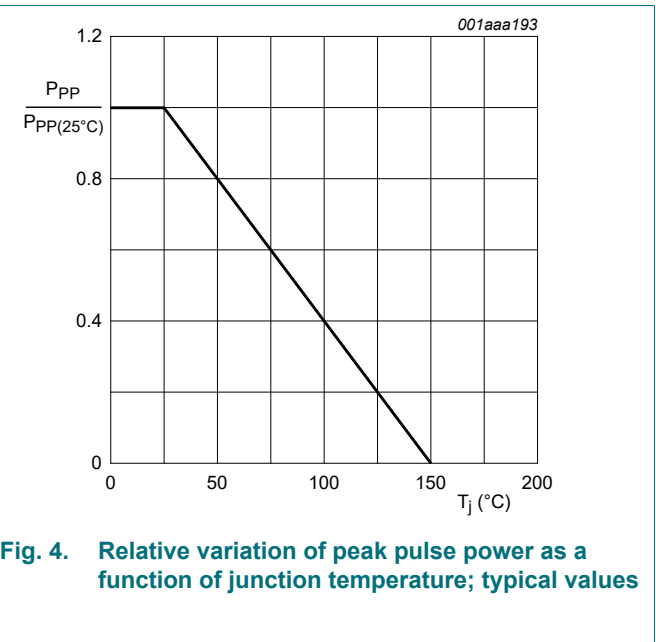
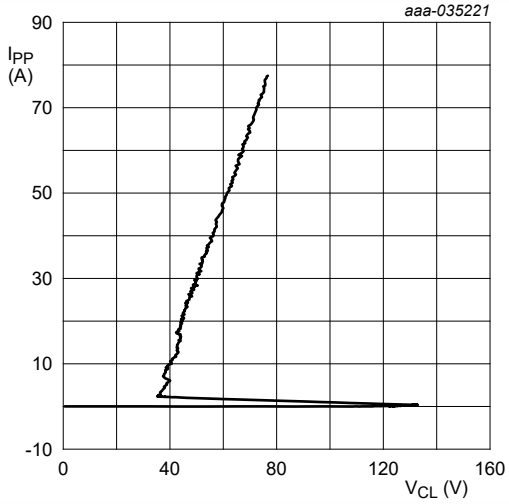
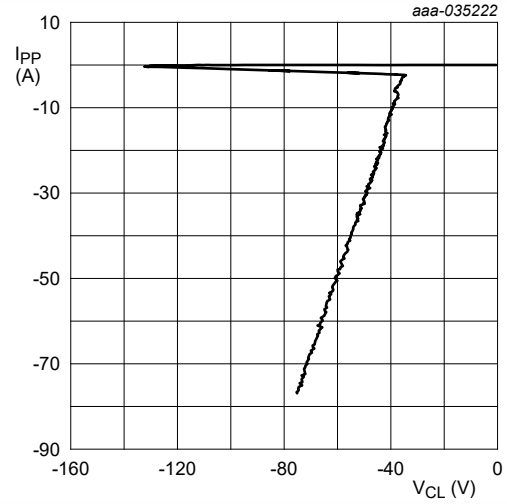


Fig. 4. Relative variation of peak pulse power as a function of junction temperature; typical values



Transmission Line Pulse (TLP);
 $t_p = 100 \text{ ns}$; $t_r = 1 \text{ ns}$

Fig. 5. Dynamic resistance with positive clamping; typical values



Transmission Line Pulse (TLP);
 $t_p = 100 \text{ ns}$; $t_r = 1 \text{ ns}$

Fig. 6. Dynamic resistance with negative clamping; typical values

10. Application information

In the „IEEE 100BASE-T1 EMC Test Specification for ESD suppression devices“¹ document (further referred as OPEN Alliance 100BASE-T1 specification), the OPEN Alliance describes four different tests to ensure compliance of ESD suppressor devices and PHYs which are compliant according to the document “Transceiver EMC Test Specification”. This device passes all tests as shown on figures 6 to 16. Furthermore, it complies with the requirements mentioned in Section 2.2. of „IEEE 100BASE-T1 EMC Test Specification for ESD suppression devices“.

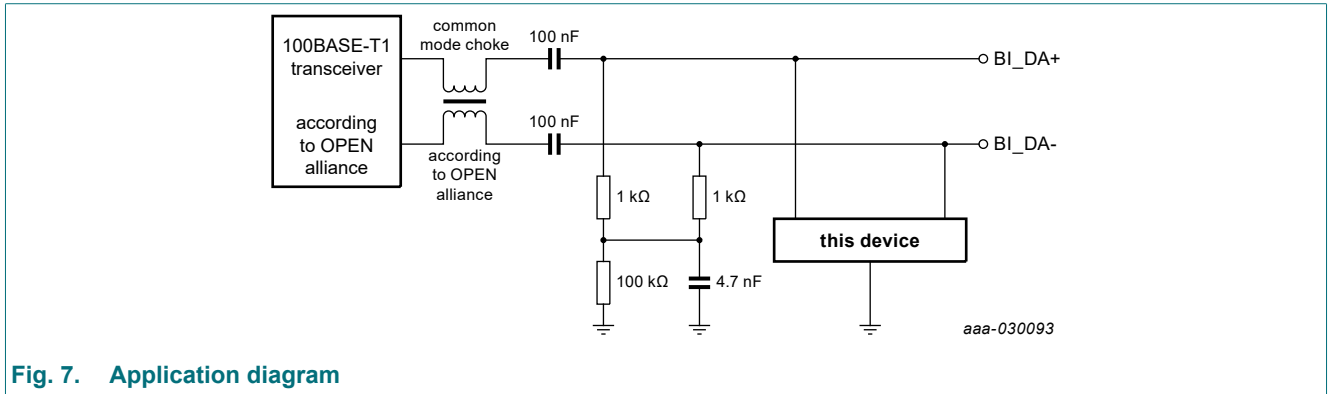


Fig. 7. Application diagram

The return loss and insertion loss are evaluated using the differential S-parameters S_{dd11} and S_{dd21} . These measurements replace the requirement for a certain capacitance value. To ensure symmetry, the differential to common mode rejection is evaluated using the S-parameter S_{sd21} . This measurement replaces the requirement for a matching of the capacitances per line. To ensure that the device does not degrade and changes behavior after repetitive ESD events, the S-parameter measurements are repeated after discharging 20 times ± 8 kV ESD on signal lines 1 and 2, with $C = 150$ pF, $R = 330 \Omega$ according to ISO 10605. Subsequently, the S-parameters are measured again and compared to the original data.

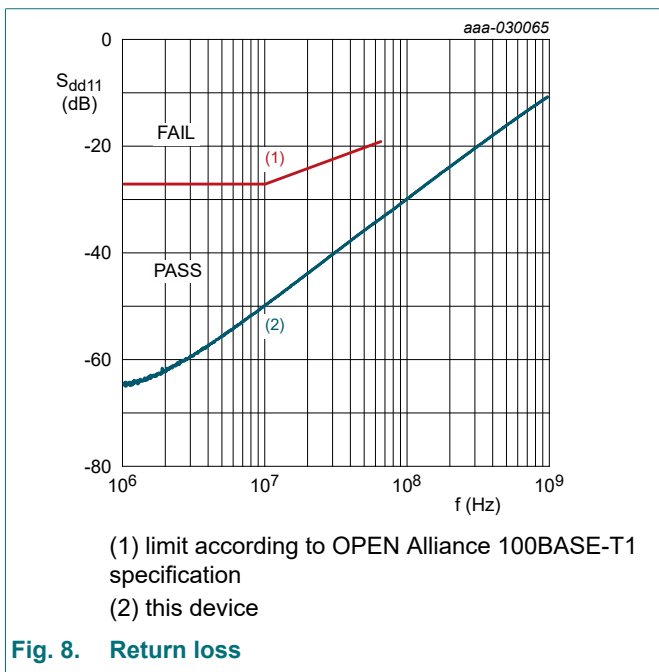


Fig. 8. Return loss

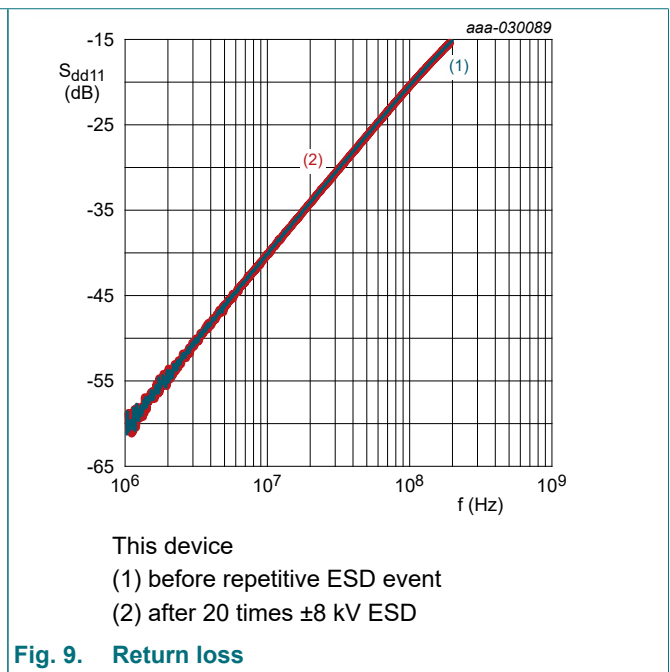
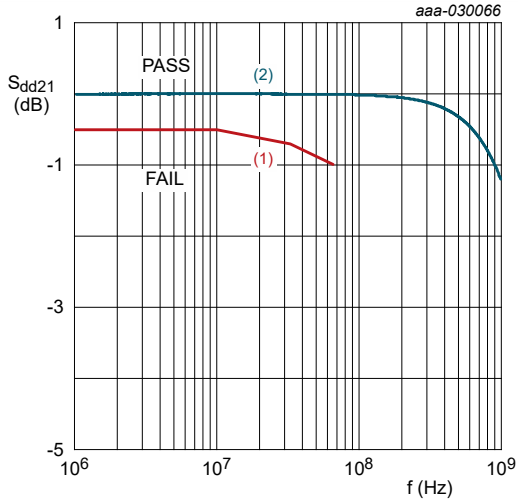


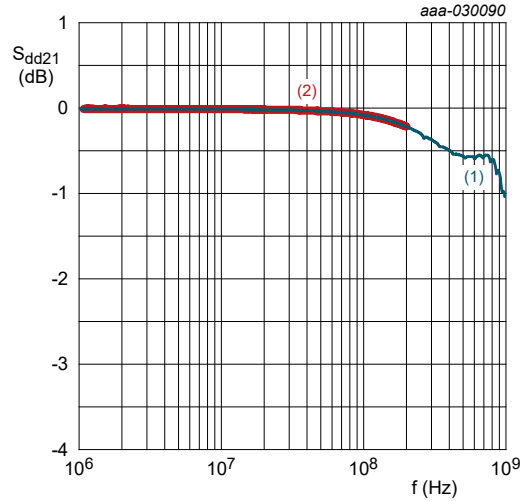
Fig. 9. Return loss

¹ OPEN Alliance: “IEEE 100BASE-T1 EMC Test Specification for ESD suppression devices”, version 1.0 rev. draft, December 10, 2018



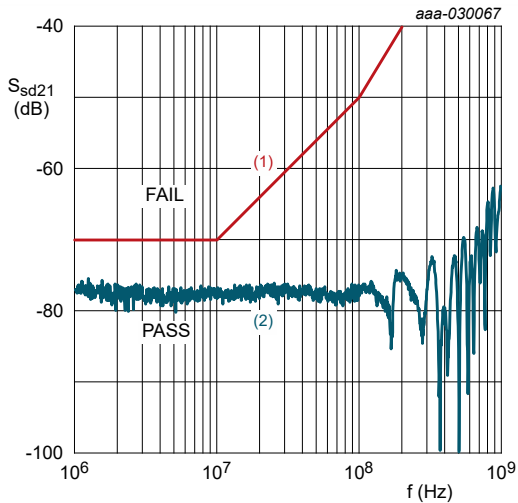
(1) limit according to OPEN Alliance 100BASE-T1 specification
 (2) this device

Fig. 10. Insertion loss



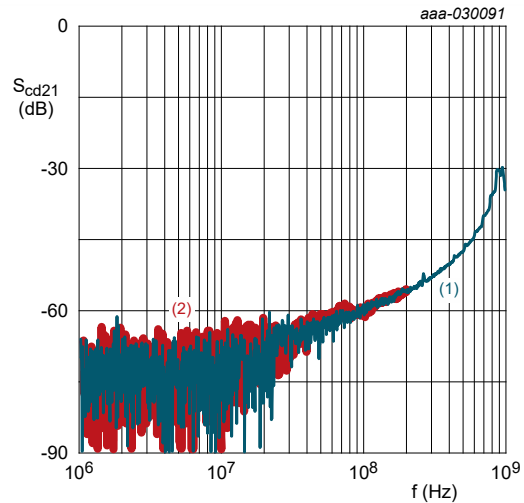
This device
 (1) before repetitive ESD event
 (2) after 20 times ±8 kV ESD

Fig. 11. Insertion loss



(1) limit according to OPEN Alliance 100BASE-T1 specification
 (2) this device

Fig. 12. Differential to common mode rejection



This device
 (1) before repetitive ESD event
 (2) after 20 times ±8 kV ESD

Fig. 13. Differential to common mode rejection

To predict if the ESD suppressor device would protect a PHY of a certain robustness class (Class I (JEDEC-HBM 4 kV) and Class II (JEDEC-HBM 2 kV)), the ESD discharge current is measured in a reference circuit according to OPEN Alliance 100BASE-T1 specification for ± 4 kV and ± 6 kV according to IEC 61000-4-2 with $C = 150$ pF and $R = 330 \Omega$. Unlike in the OPEN Alliance 100BASE-T1 specification of October 29 2017, the „Transceiver Simulation network“ is implemented with 2Ω and 50Ω resistors.

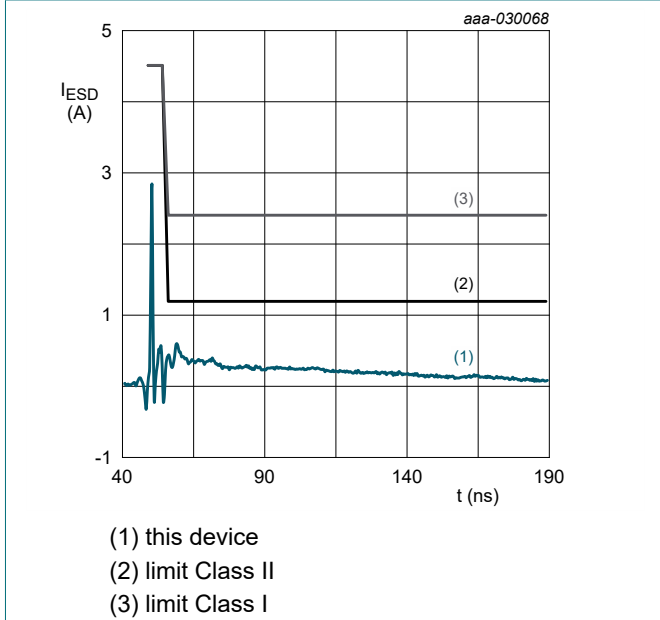


Fig. 14. ESD discharge current at +4 kV

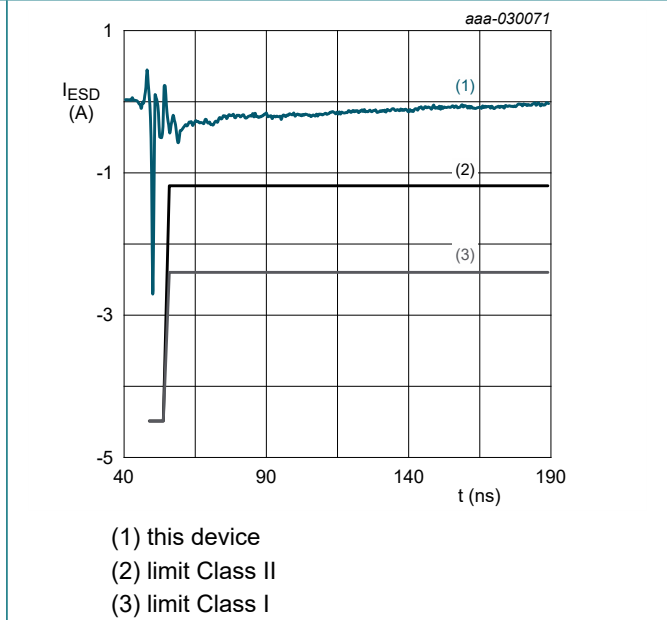


Fig. 15. ESD discharge current at -4 kV

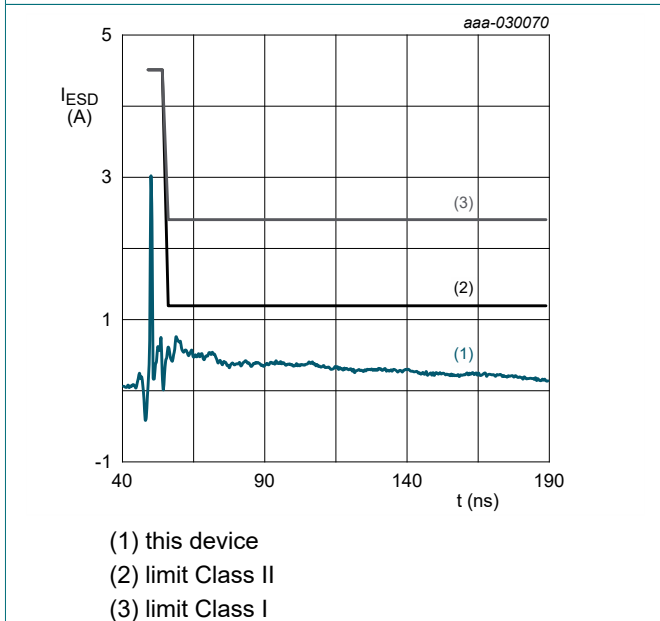


Fig. 16. ESD discharge current at +6 kV

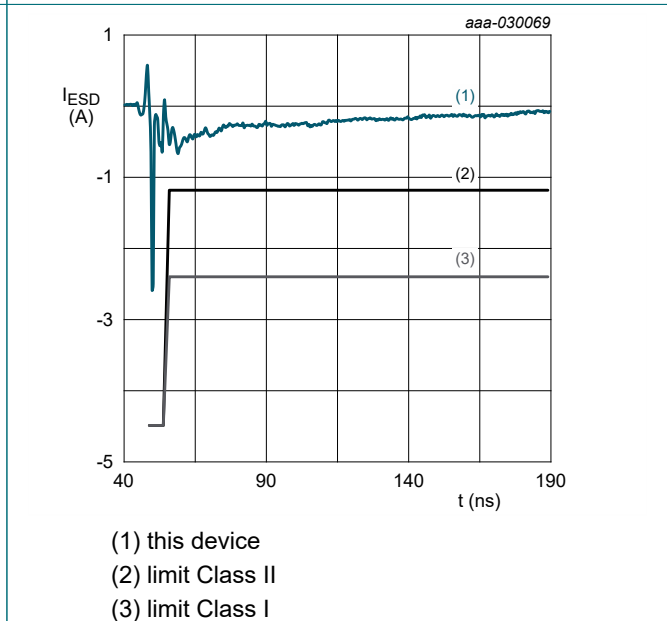
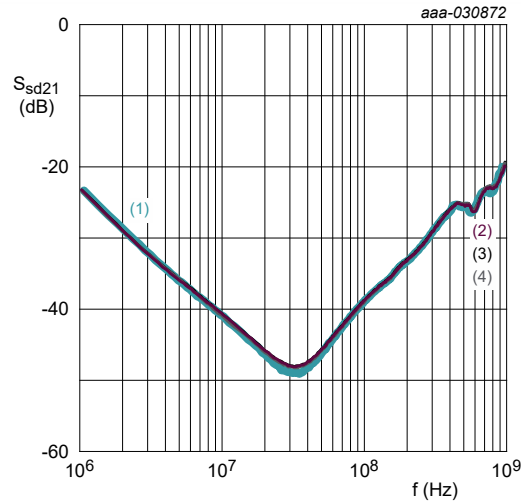


Fig. 17. ESD discharge current at -6 kV

To ensure that the ESD suppressor device is not impacting the EMC performance of the complete module, the RF clamping test as defined in the OPEN Alliance specification is applied. First a measurement at a reference power level of 25 dBm is conducted in an environment defined by the OPEN Alliance 100BASE-T1 specification. Next, the power is increased to 33 dBm (Class I), 36 dBm (Class II), and 39 dBm (Class III). No change in the measured common mode rejection indicates that the ESD suppressor device is not impacting the modules EMC performance.



According to OPEN Alliance 100BASE-T1 specification

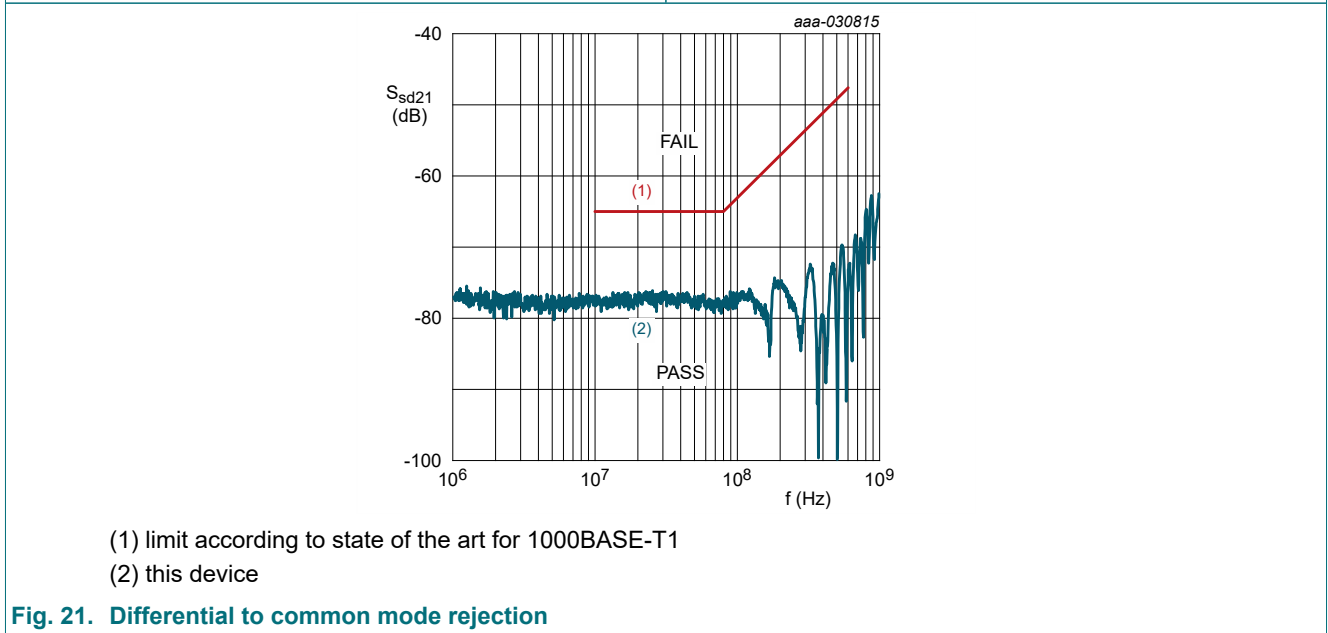
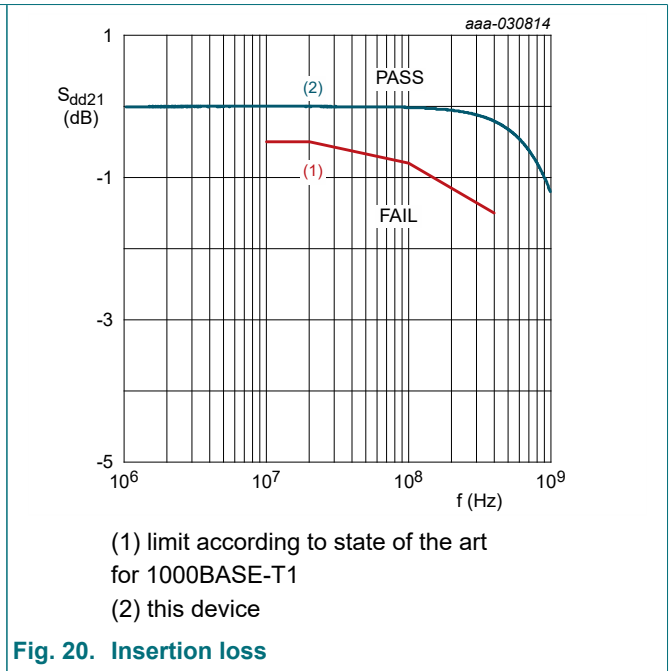
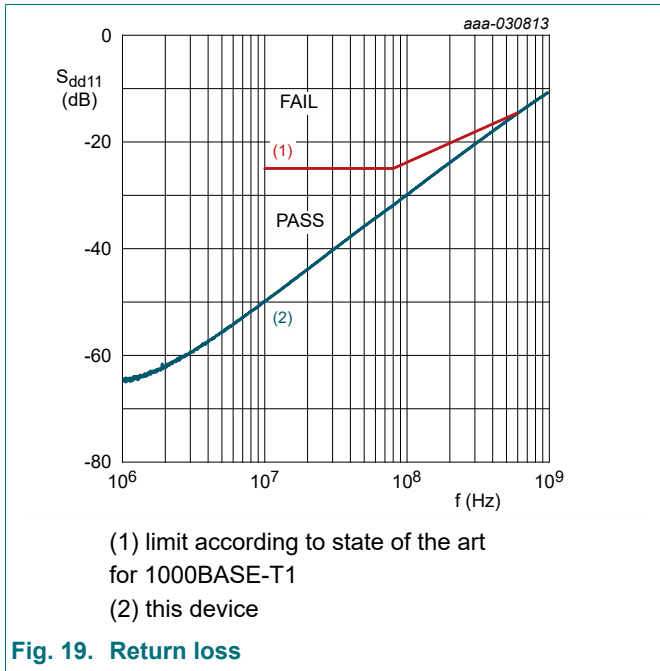
Common mode rejection for:

- (1) reference
- (2) Class I
- (3) Class II
- (4) Class III

Fig. 18. RF Clamping Test

For 1000BASE-T1, there is no published document on the requirements for external ESD suppressor devices. However, a similar requirement specification is in preparation at the time the present document is created. To support the conformity of this device with the to-be-published requirement specification of OPEN Alliance for 1000BASE-T1, results of tests adapted from OPEN Alliance specification for 100BASE-T1 are shown. In these tests, limits are adapted to the current state of the art and the common-mode choke is selected in compliance with the published OPEN Alliance document “IEEE 1000BASE-T1 EMC Test Specification for Common Mode Chokes Version 1.0” as of January 16, 2018.

The following graphs show the S-parameters with adapted limit lines. ESD damage test results of 100BASE-T1 are also valid for 1000BASE-T1.



The following graphs show the discharge current measurements, with a 1000BASE-T1 compliant common-mode choke.

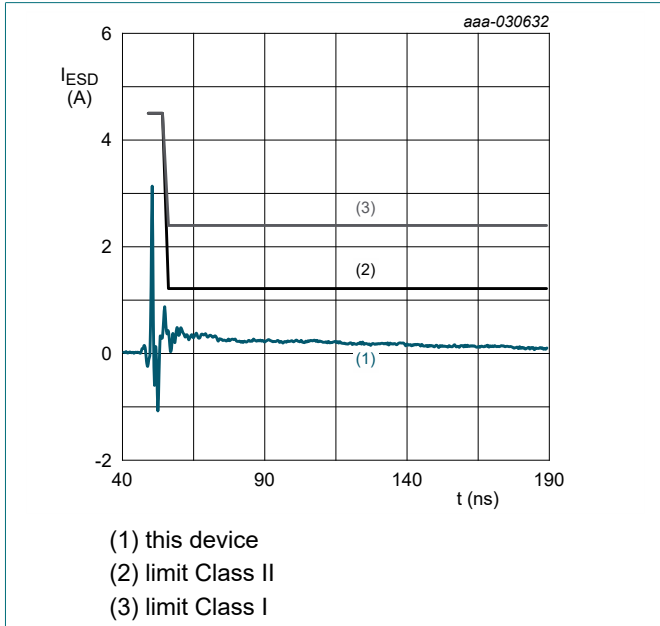


Fig. 22. ESD discharge current at +4 kV

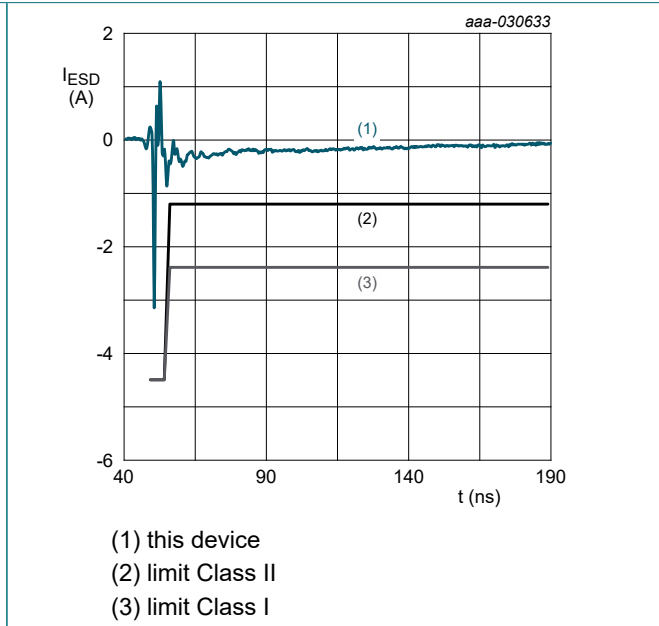


Fig. 23. ESD discharge current at -4 kV

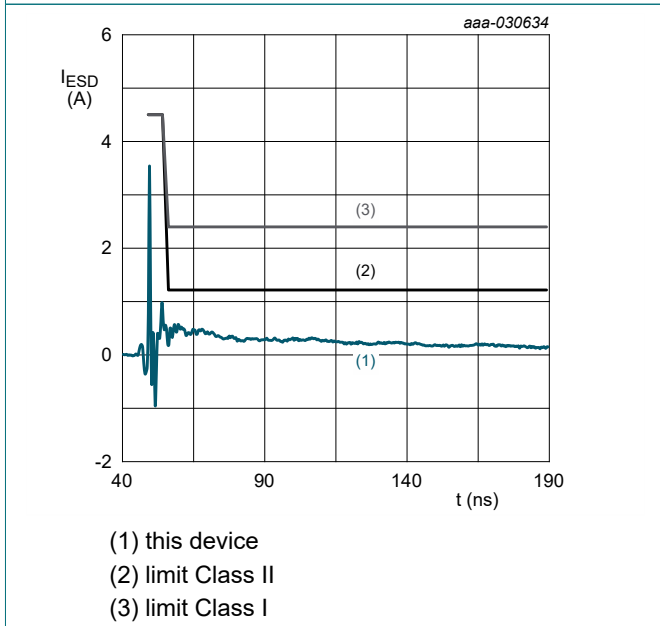


Fig. 24. ESD discharge current at +6 kV

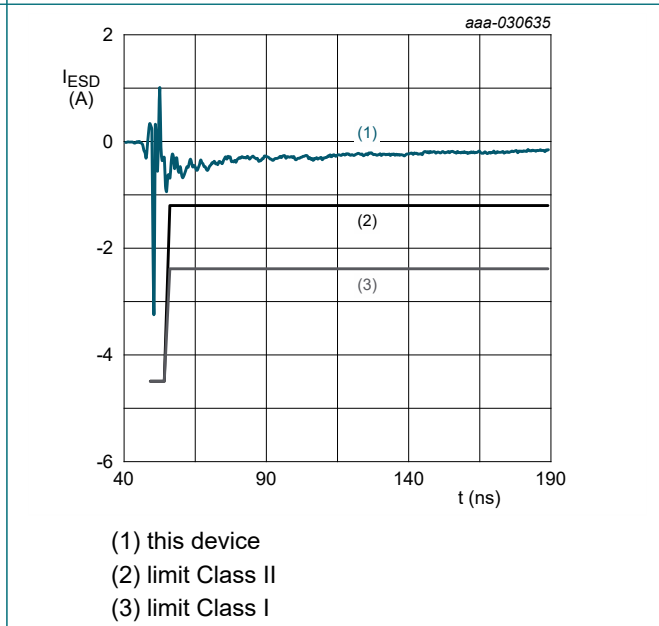
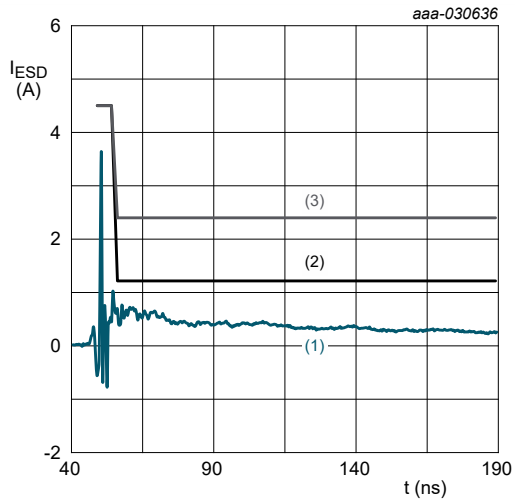
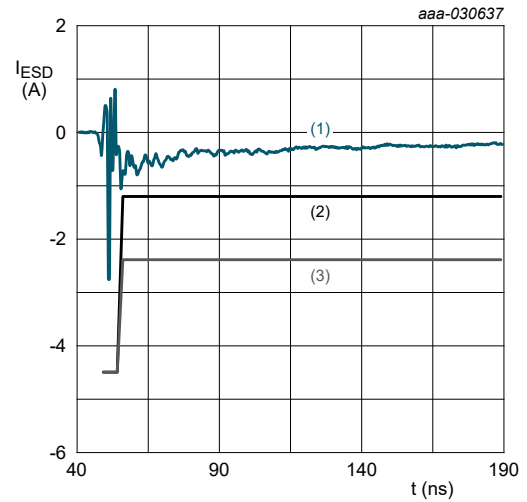


Fig. 25. ESD discharge current at -6 kV



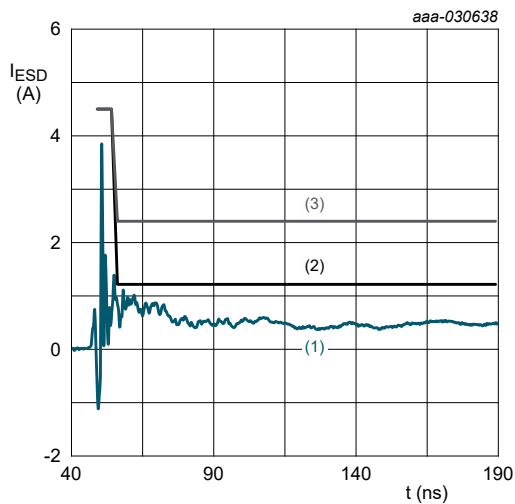
- (1) this device
- (2) limit Class II
- (3) limit Class I

Fig. 26. ESD discharge current at +8 kV



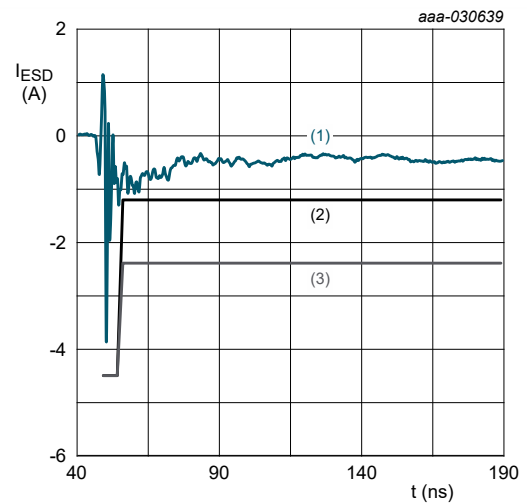
- (1) this device
- (2) limit Class II
- (3) limit Class I

Fig. 27. ESD discharge current at -8 kV



- (1) this device
- (2) limit Class II
- (3) limit Class I

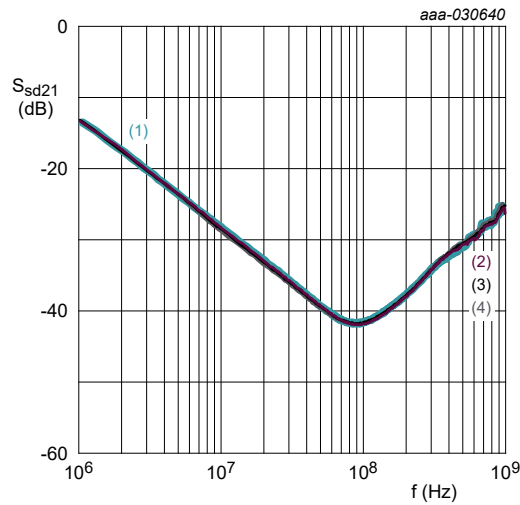
Fig. 28. ESD discharge current at +15 kV



- (1) this device
- (2) limit Class II
- (3) limit Class I

Fig. 29. ESD discharge current at -15 kV

The following graph shows the RF clamping test with a 1000BASE-T1 compliant common-mode choke.



According to state of the art for 1000BASE-T1

Common mode rejection for:

- (1) reference
- (2) Class I
- (3) Class II
- (4) Class III

Fig. 30. RF Clamping Test

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

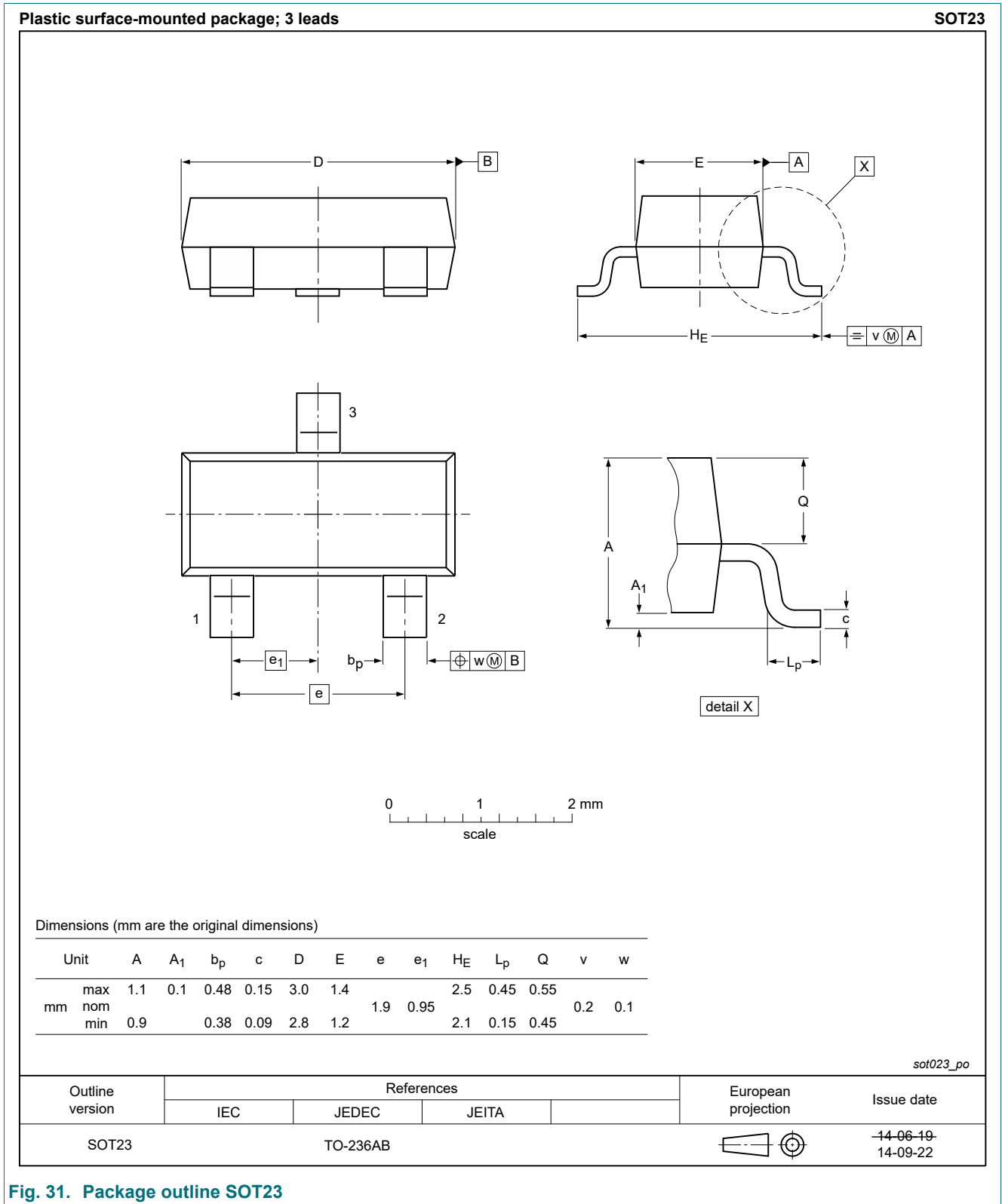


Fig. 31. Package outline SOT23

13. Soldering

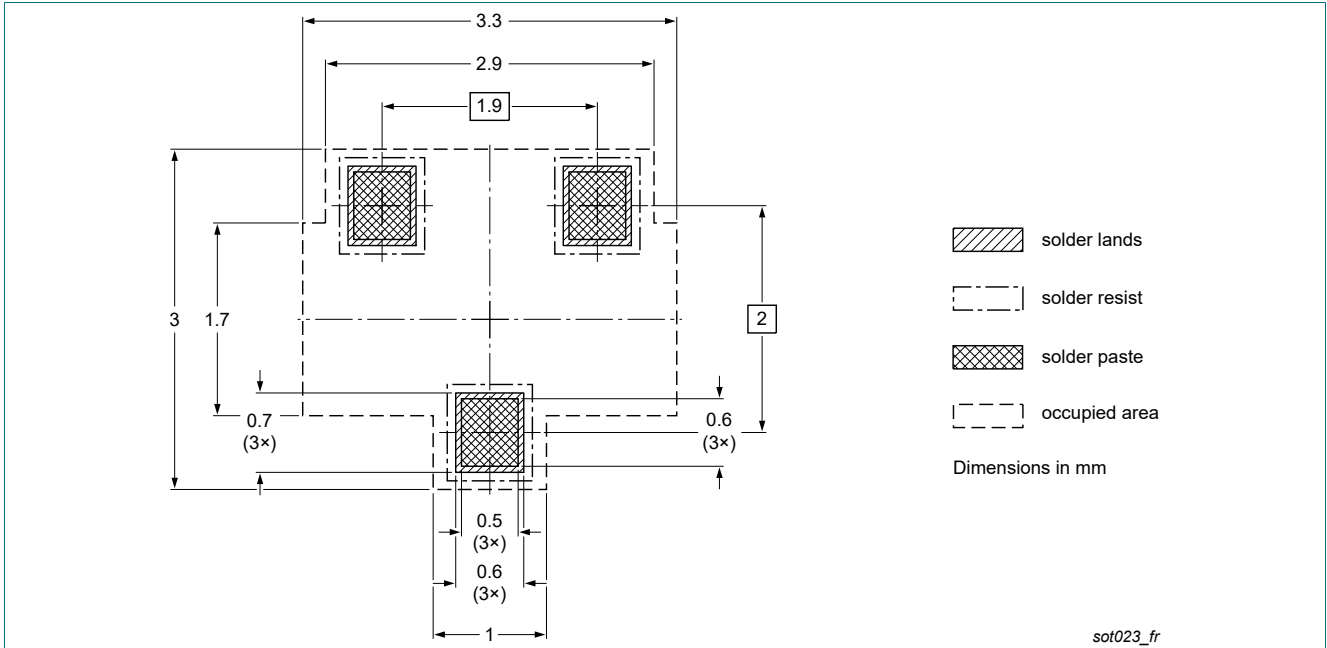


Fig. 32. Reflow soldering footprint for SOT23

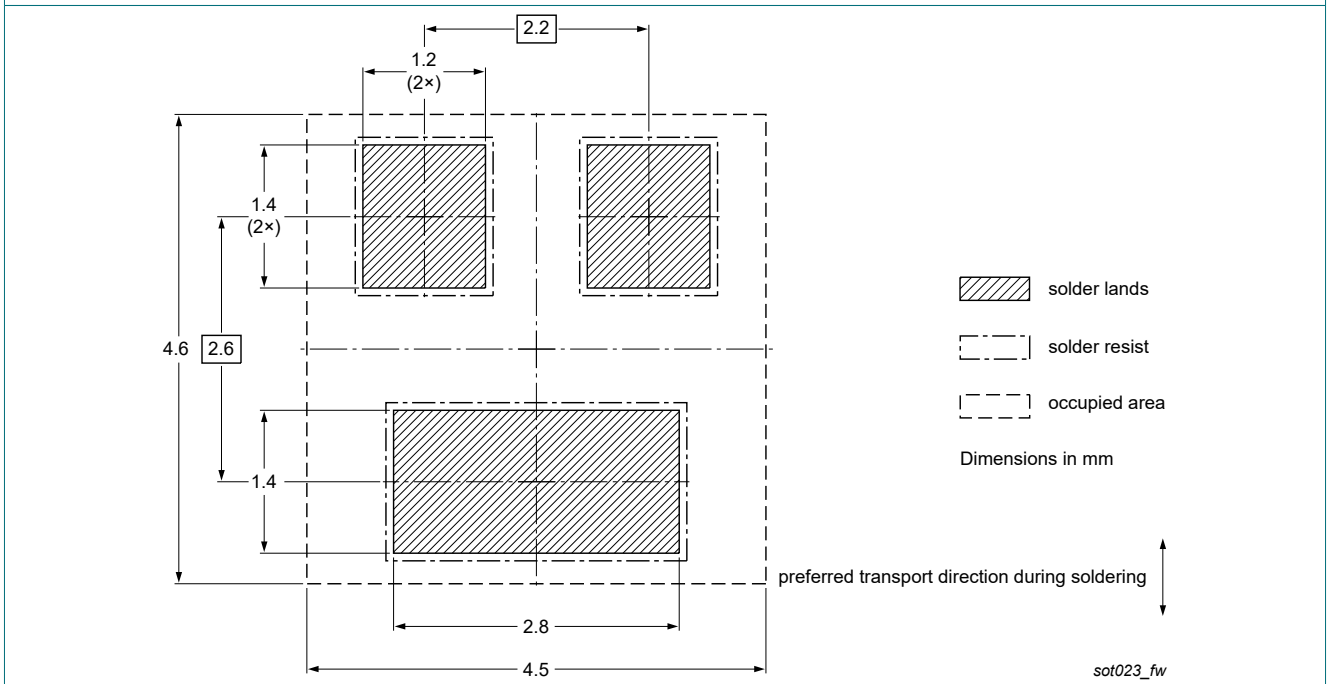


Fig. 33. Wave soldering footprint for SOT23

14. Revision history

Table 7. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PESD2ETH1GT-Q v.1	20230329	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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